





#### HIGH VOLTAGE SWITCHING DIODE

### **Features**

- Fast Switching Speed: 50ns Maximum
- 400V High Reverse Breakdown Voltage Rating
- Low Capacitance: 2.5pF Maximum
- Surface Mount Package Ideally Suited for Automated Insertion
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Alloy 42 Leadframe.
  Lead Free Plating. Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.005 grams (Approximate)

#### **SOD323**



Top View

### **Ordering Information (Note 5)**

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BAV5004WSQ-7	Automotive	LY	7	8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



LY = Product Type Marking Code Bar Denotes Cathode Side

### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	400	V
Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RWM</sub> V <sub>R</sub>	350	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	247	V
Forward Continuous Current (Note 6)	I <sub>FM</sub>	300	mA
Peak Repetitive Forward Current (Note 6)	I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0µs	I = 0.4	5.0 3.0	А

Note: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.



### **Thermal Characteristics**

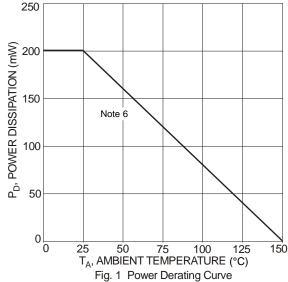
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6) (See Figure 1)	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

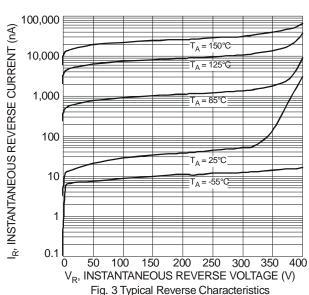
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

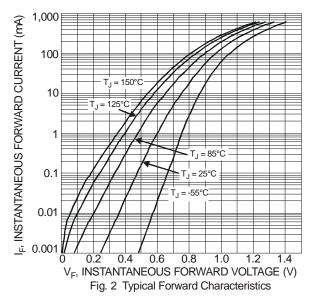
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	400	_	-	V	$I_R = 150\mu A$
	V <sub>F</sub>	_	-	0.93		$I_F = 20mA$
Forward Voltage		_	_	1.09	V	$I_F = 100 \text{mA}$
		_	_	1.29		$I_F = 200 \text{mA}$
Reverse Current (Note 7)	I <sub>R</sub>	-	_	1	μΑ	V <sub>R</sub> = 240V
Reverse Current (Note 1)		_	_	100	μΑ	$V_R = 240V, T_J = +150$ °C
Total Capacitance	C <sub>T</sub>	-	0.9	2.5	pF	$V_R = 0V, f = 1.0MHz$
Reverse Recovery Time	<b>+</b>		_	50	ns	$I_F = I_R = 30 \text{mA},$
Neverse Necovery Time	t <sub>RR</sub>	_				$I_F = I_R = 30\text{mA},$ $I_{RR} = 3.0\text{mA}, R_L = 100\Omega$

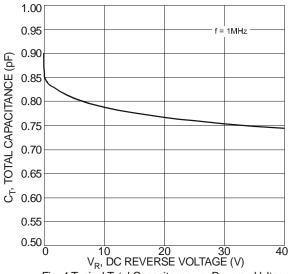
Notes:

- 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.







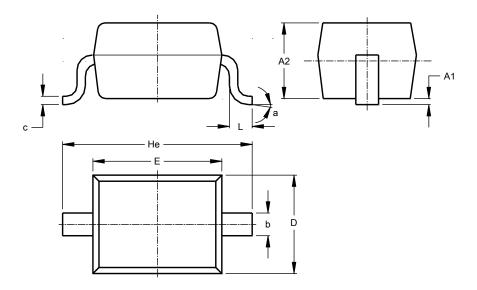




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOD323**

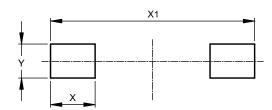


SOD323					
Dim	Min	Max	Тур		
A1		0.10	0.05		
A2	1.00	1.10	1.05		
b	0.25	0.35	0.30		
С	0.10	0.15	0.11		
D	1.20	1.40	1.30		
Е	1.60	1.80	1.70		
He	2.30	2.70	2.50		
L	0.20	0.40	0.30		
а	00	8º			
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOD323**



Dimensions	Value (in mm)
Х	0.590
X1	2.700
Υ	0.450



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